

Title (en)

METHOD FOR TRANSFER MOLDING STANDARD ELECTRONIC PACKAGES AND APPARATUS FORMED THEREBY

Title (de)

VERFAHREN ZUM TRANSFERGIESSEN VON ELEKTRONISCHEN STANDARDTEILEN UND SO GEFORMTESGERÄT

Title (fr)

PROCEDE DE MOULAGE PAR TRANSFERT DES MODULES ELECTRONIQUES STANDARD ET APPAREIL AINSI FORME

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Application

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